

## PERSONAL

- Azmi Zhafry bin Ahmad Tarmizi
- 23 years old
- No 82, Lorong Emas 2/1, Taman Emas, 09000 Kulim, Kedah.
- 016-4442186
- azmizhafry@gmail.com
- Linkedin.com/in/azmizhafryahmad
- Motto- Excel through experiences

# STRENGTH

- Owned a green card CIDB.
- Technical support member in International Integrated Engineering Summit (IIES 2014).
- Participant of invention Smart tap water in Research & Inovation Festival at UTHM.
- Have a basic of welding certificate done at IKBN.
- Fast learner and independent with critical thinking skills.



 Dr. Saliza Azlina binti Osman Lecturer at UTHM 013-3898989 ieyjasaliza@uthm.edu.my

Other Reference are available on request



### **EXPECTED SALARY**

RM2300 (Negotiable)

## **OBJECTIVE**

To apply Mechanical Engineer position at company and apply knowledge into related field such as operation, production, manufacturing, maintenance, and R&D.

### WORK EXPERIENCES

 Maintenance Technician Internship (RUZA Resources Manufacturing Sdn. Bhd.)

Kulim, Kedah (June 2016- September 2016)

- ◆ Responsible for the handling, performance of machinery and functional inspection of all tooling.
- Technical Clerk (MPA Consultant Sdn. Bhd.)
  Seberang Jaya, Penang (March 2012- May 2012)
  - ◆ Responsible in taking coordinate for site surveying and scheduling the project.



#### **EDUCATION**

- Degree of Mechanical Engineering with Honours.
  Universiti Tun Hussein Onn Malaysia (UTHM) (2013-2017)
- Certificate.
  Kolej Matrikulasi Teknikal Kedah (2012-2013)



#### **SOFTWARE**

**SolidWorks** \*\*\*\* **AutoCAD** \*\*\*\* Microsoft Excel \*\*\*\* Microsoft Powerpoint \*\*\*\* Microsoft Project \*\*\*\* Microsoft Word \*\*\*\* \*\*\*\* **CATIA** C++ programming \*\*\*\*

### P

#### **PROJECTS**

Mechanical Component Design

(Design a suitable gearbox system which satisfies the torque motor requirement)

- ◆ Concept development (sketching), engineering analysis (power, gear fundamental, gear failure, shaft and bearing analysis), and detail design (engineering design)
- Final Year Project

(Run a lab testing and analysis on the effect additional element of Bi and Cu in lead-free solders during multiple reflow process)

◆ To decrease the defect of solder joint thickness which affects the printed circuit board (PCB) lifetime.

### MOBILITY & AVAILABILITY

Mobility (Motorcycle)

Availability

(Immediately)